semiconductor hereinafter described, and a layer on said first III-V compound semiconductor and said pattern from said second III-V compound semiconductor expressed by the general formula $In_xGa_yAl_zN$ where $0\le x\le 1$, $0\le y\le 1$, $0\le z\le 1$, and x+y+z=1, wherein the full width at half maximum of the (0004) reflection X-ray rocking curve of said second III-V compound semiconductor is 700 seconds or less regardless of the direction of X-ray incidence, and the compound semiconductor is formed by a vapor phase epitaxy method.

control

2. (Twice Amended) A III-V compound semiconductor having a first layer that comprises a first III-V compound semiconductor expressed by the general formula $In_uGa_vAL_wN$ where $0\le u\le 1$, $0\le v\le 1$, $0 \le w \le 1$, and u+v+w=1, a pattern on said first layer from a material different not only from said first III-V compound semiconductor but also from а second III-V semiconductor hereinafter described, and a layer on said first III-V compound semiconductor and said pattern from said second III-V compound semiconductor expressed by the general formula $In_xGa_vAl_zN$ where $0 \le x \le 1$, $0 \le y \le 1$, $0 \le z \le 1$, and x + y + z = 1, wherein an upper surface of said pattern is not in contact with said III-V compound semiconductor, second and the semiconductor is formed by a vapor phase epitaxy method.